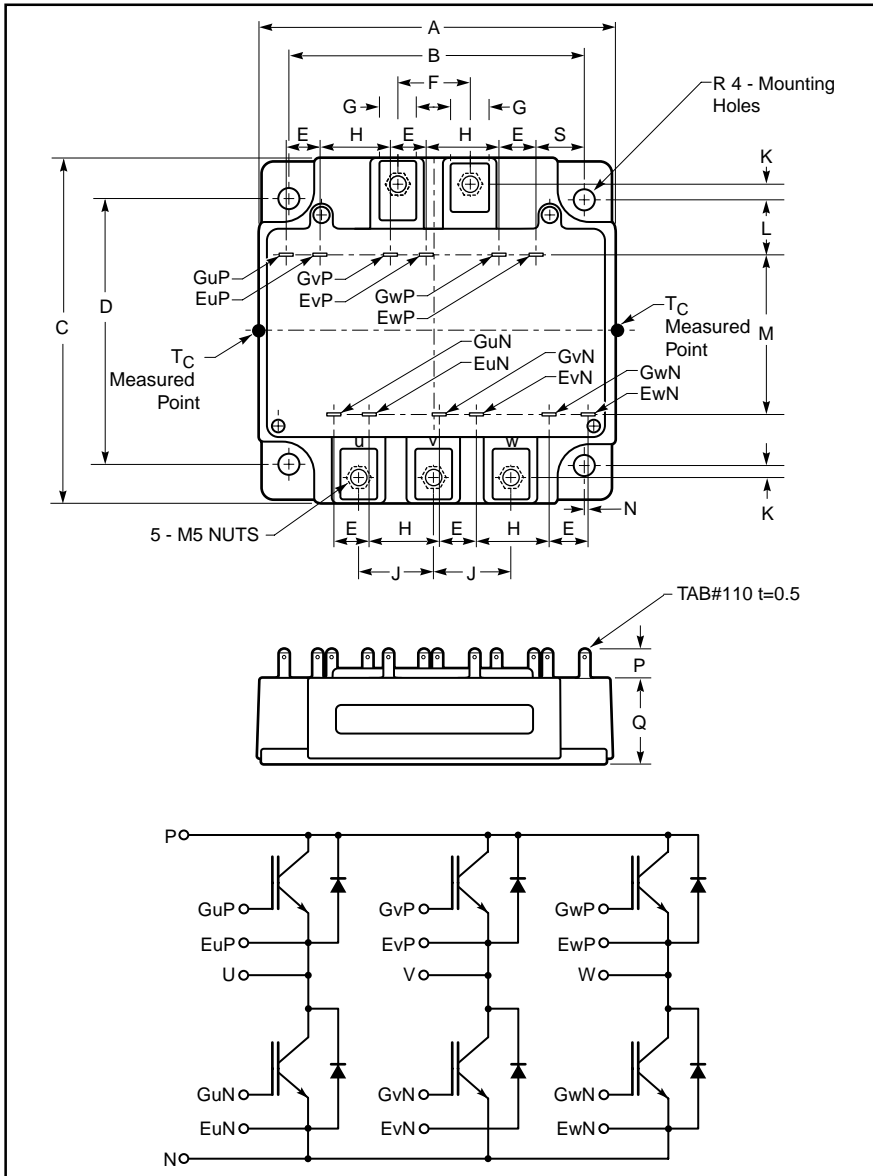


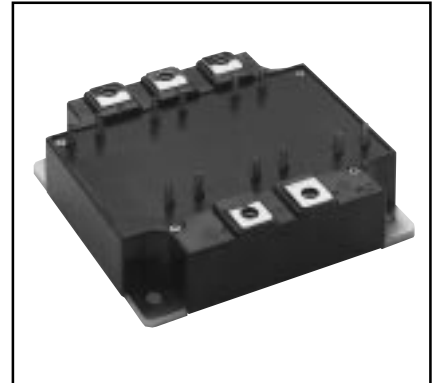
MITSUBISHI IGBT MODULES
CM75TU-24H
 HIGH POWER SWITCHING USE
 INSULATED TYPE



Outline Drawing and Circuit Diagram

Dimensions	Inches	Millimeters
A	4.21	107.0
B	3.54±0.01	90.0±0.25
C	4.02	102.0
D	3.15±0.01	80.0±0.25
E	0.43	11.0
F	0.91	23.0
G	0.47	12.0
H	0.85	21.7
J	0.91	23.0

Dimensions	Inches	Millimeters
K	0.15	3.75
L	0.67	17.0
M	1.91	48.5
N	0.03	0.8
P	0.32	8.1
Q	1.02	26.0
R	0.22 Dia.	5.5 Dia.
S	0.57	14.4



Description:

Mitsubishi IGBT Modules are designed for use in switching applications. Each module consists of six IGBTs in a three phase bridge configuration, with each transistor having a reverse-connected super-fast recovery free-wheel diode. All components and interconnects are isolated from the heat sinking baseplate, offering simplified system assembly and thermal management.

Features:

- Low Drive Power
- Low $V_{CE(sat)}$
- Discrete Super-Fast Recovery Free-Wheel Diode
- High Frequency Operation
- Isolated Baseplate for Easy Heat Sinking

Applications:

- AC Motor Control
- Motion/Servo Control
- UPS
- Welding Power Supplies

Ordering Information:

Example: Select the complete module number you desire from the table - i.e. CM75TU-24H is a 1200V (V_{CES}), 75 Ampere Six-IGBT Module.

Type	Current Rating Amperes	V_{CES} Volts (x 50)
CM	75	24

CM75TU-24H

HIGH POWER SWITCHING USE
INSULATED TYPEAbsolute Maximum Ratings, $T_j = 25\text{ }^\circ\text{C}$ unless otherwise specified

Ratings	Symbol	CM75TU-24H	Units
Junction Temperature	T_j	-40 to 150	$^\circ\text{C}$
Storage Temperature	T_{stg}	-40 to 125	$^\circ\text{C}$
Collector-Emitter Voltage (G-E SHORT)	V_{CES}	1200	Volts
Gate-Emitter Voltage (C-E SHORT)	V_{GES}	± 20	Volts
Collector Current ($T_c = 25\text{ }^\circ\text{C}$)	I_C	75	Amperes
Peak Collector Current ($T_j \leq 150\text{ }^\circ\text{C}$)	I_{CM}	150*	Amperes
Emitter Current**	I_E	75	Amperes
Peak Emitter Current**	I_{EM}	150*	Amperes
Maximum Collector Dissipation ($T_j < 150\text{ }^\circ\text{C}$)	P_C	600	Watts
Mounting Torque, M5 Main Terminal	–	2.5–3.5	N · m
Mounting Torque, M5 Mounting	–	2.5–3.5	N · m
Weight	–	680	Grams
Isolation Voltage (Main Terminal to Baseplate, AC 1 min.)	V_{iso}	2500	Vrms

* Pulse width and repetition rate should be such that the device junction temperature (T_j) does not exceed $T_{j(max)}$ rating.

**Represents characteristics of the anti-parallel, emitter-to-collector free-wheel diode (FWDi).

Static Electrical Characteristics, $T_j = 25\text{ }^\circ\text{C}$ unless otherwise specified

Characteristics	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Collector-Cutoff Current	I_{CES}	$V_{CE} = V_{CES}, V_{GE} = 0V$	–	–	1	mA
Gate Leakage Voltage	I_{GES}	$V_{GE} = V_{GES}, V_{CE} = 0V$	–	–	0.5	μA
Gate-Emitter Threshold Voltage	$V_{GE(th)}$	$I_C = 7.5\text{mA}, V_{CE} = 10V$	4.5	6	7.5	Volts
Collector-Emitter Saturation Voltage	$V_{CE(sat)}$	$I_C = 75A, V_{GE} = 15V, T_j = 25\text{ }^\circ\text{C}$	–	2.9	3.7	Volts
		$I_C = 75A, V_{GE} = 15V, T_j = 125\text{ }^\circ\text{C}$	–	2.85	–	Volts
Total Gate Charge	Q_G	$V_{CC} = 600V, I_C = 75A, V_{GE} = 15V$	–	280	–	nC
Emitter-Collector Voltage*	V_{EC}	$I_E = 75A, V_{GE} = 0V$	–	–	3.2	Volts

* Pulse width and repetition rate should be such that the device junction temperature (T_j) does not exceed $T_{j(max)}$ rating.Dynamic Electrical Characteristics, $T_j = 25\text{ }^\circ\text{C}$ unless otherwise specified

Characteristics	Symbol	Test Conditions	Min.	Typ.	Max.	Units	
Input Capacitance	C_{ies}		–	–	11	nF	
Output Capacitance	C_{oes}	$V_{CE} = 10V, V_{GE} = 0V$	–	–	3.7	nF	
Reverse Transfer Capacitance	C_{res}		–	–	2.2	nF	
Resistive	Turn-on Delay Time	$t_{d(on)}$	$V_{CC} = 600V, I_C = 75A,$	–	–	100	ns
	Rise Time	t_r	$V_{GE1} = V_{GE2} = 15V,$	–	–	200	ns
Switch	Turn-off Delay Time	$t_{d(off)}$	$R_G = 4.2\Omega, \text{Resistive}$	–	–	250	ns
Times	Fall Time	t_f	Load Switching Operation	–	–	350	ns
Diode Reverse Recovery Time	t_{rr}	$I_E = 75A, di_E/dt = -150A/\mu\text{s}$	–	–	300	μC	
Diode Reverse Recovery Charge	Q_{rr}	$I_E = 75A, di_E/dt = -150A/\mu\text{s}$	–	0.41	–	μC	

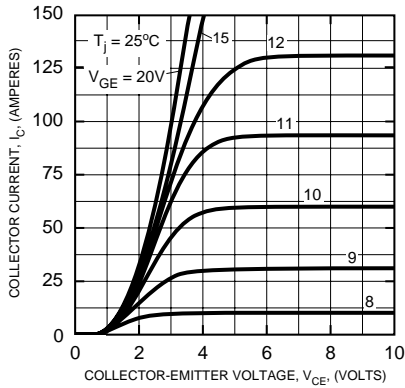
Thermal and Mechanical Characteristics, $T_j = 25\text{ }^\circ\text{C}$ unless otherwise specified

Characteristics	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Thermal Resistance, Junction to Case	$R_{th(j-c)Q}$	Per IGBT 1/6 Module	–	–	0.21	$^\circ\text{C/W}$
Thermal Resistance, Junction to Case	$R_{th(j-c)D}$	Per Free-Wheel Diode 1/6 Module	–	–	0.47	$^\circ\text{C/W}$
Contact Thermal Resistance	$R_{th(c-f)}$	Per Module, Thermal Grease Applied	–	0.015	–	$^\circ\text{C/W}$

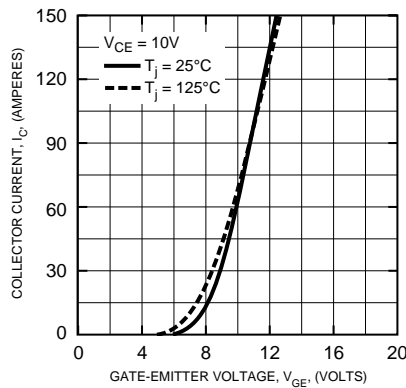
CM75TU-24H

HIGH POWER SWITCHING USE
INSULATED TYPE

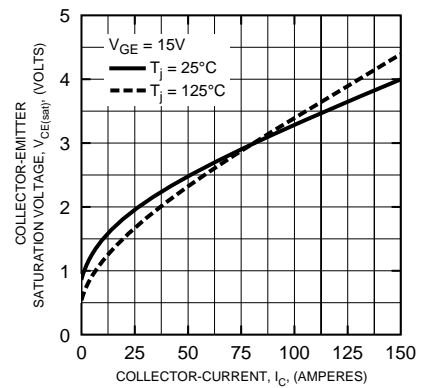
OUTPUT CHARACTERISTICS
(TYPICAL)



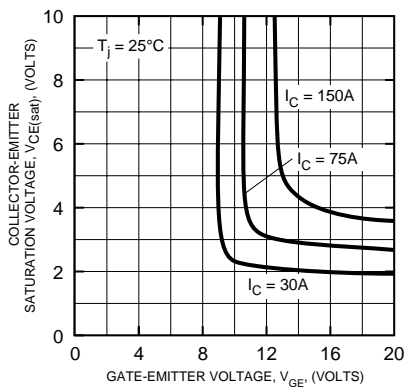
TRANSFER CHARACTERISTICS
(TYPICAL)



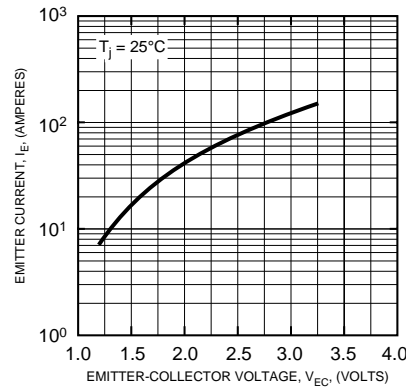
COLLECTOR-EMITTER SATURATION VOLTAGE CHARACTERISTICS
(TYPICAL)



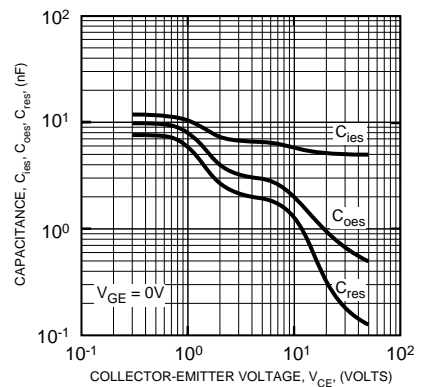
COLLECTOR-EMITTER SATURATION VOLTAGE CHARACTERISTICS
(TYPICAL)



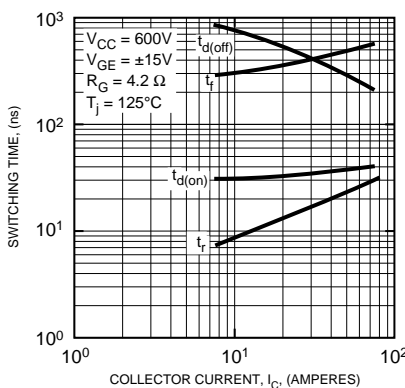
FREE-WHEEL DIODE FORWARD CHARACTERISTICS
(TYPICAL)



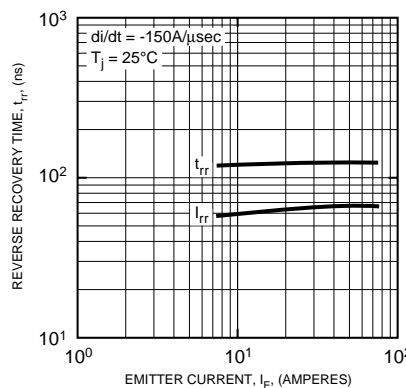
CAPACITANCE VS. V_{CE}
(TYPICAL)



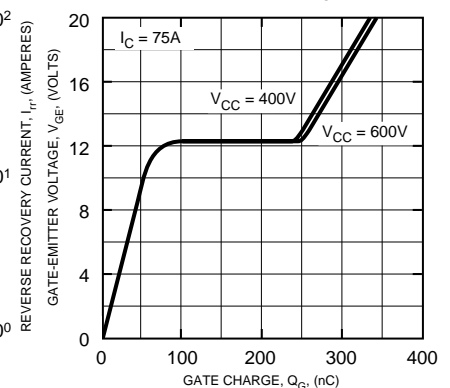
HALF-BRIDGE SWITCHING CHARACTERISTICS
(TYPICAL)



REVERSE RECOVERY CHARACTERISTICS
(TYPICAL)



GATE CHARGE, V_{GE}



CM75TU-24H

HIGH POWER SWITCHING USE
INSULATED TYPE

